

PCN Number:	20200131001	PCN Date:	Feb. 3, 2020
Title:	Datasheet for LM2775-Q1		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



LM2775-Q1

SNVSAH6B – JUNE 2018 – REVISED NOVEMBER 2019

Changes from Revision A (September 2018) to Revision B	Page
• Changed Load Regulation graph.....	1
• Changed Abs Max Ratings T_{J-MAX} 'Max' temp from 125 to 150.....	4
• Added I_{OUT} spec to Recommended Operating Conditions table.....	4
• Changed maximum ambient temp range from 85 to 125°C in the 'Condition statement of Electrical Characteristics table..	5
• Added Thermal shutdown spec to Electrical Characteristics table.....	5
• Changed T_A to $T_J = 25^\circ\text{C}$ in Conditions statement of Typical Characteristics section.....	5
• Updated Typical Characteristics graphs.....	5
• Changed T_A to $T_J = 25^\circ\text{C}$ in Conditions statement of Typical Characteristics section.....	6
• Changed T_A to $T_J = 25^\circ\text{C}$ in Conditions statement of Typical Characteristics section.....	7
• Changed T_A to $T_J = 25^\circ\text{C}$ in Conditions statement of Typical Characteristics section.....	8
• Updated Application Curve Figure 22	16

The datasheet number will be changing.

Device Family	Change From:	Change To:
LM2775-Q1	SNVSAH6A	SNVSAH6B

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/LM2775-Q1>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

LM2775QDSGRQ1	LM2775QDSGTQ1		
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For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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